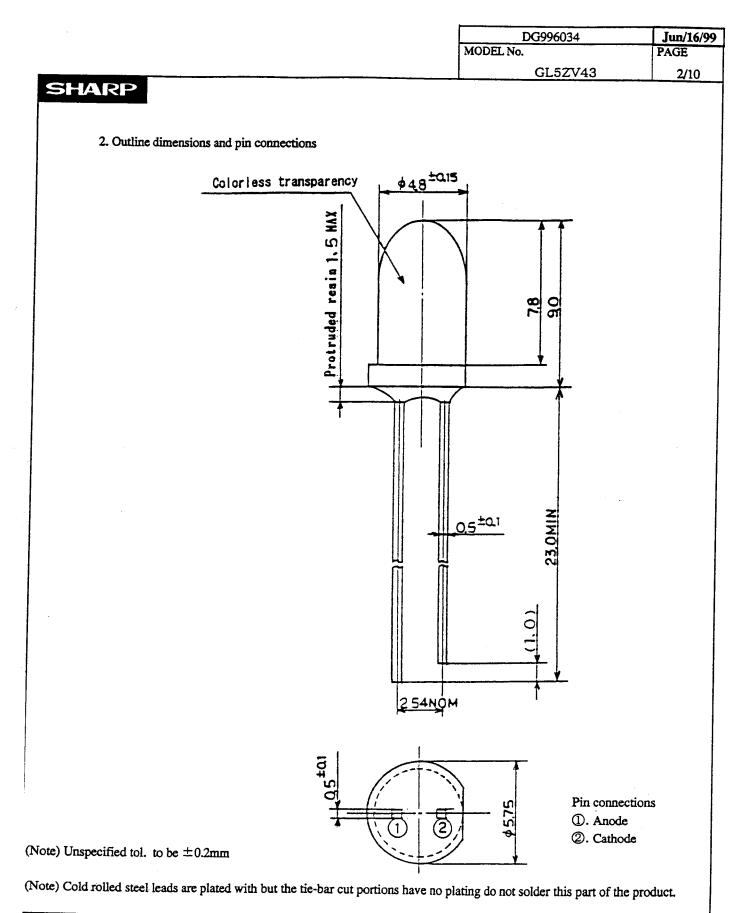
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PPROVED BY: DATE:		PAGE	10 pages
Jun / 16/99	ELECTRONIC COMPONENTS GROUP SHARP CORPORATION	REPRESENT	ATIVE DIVISION:
F. Fulense	SPECIFICATION	Opto-Electro	nic Devices Division
DEVICE	SPECIFICATION FOR Light Emitting Diode No. GL5ZV43		
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for any damage resulting from u and the instructions included in (Precautions) (1) This products is desig * OA equipment * Telecommunication * Tooling machines If the use of the produ (2) or (3), please be su (2) Appropriate measures the safety design of th and safety when this p safety in function and * Transportation con * Traffic signals * Other safety equip	act in the above application areas is for equipm are to observe the precautions given in those re- , such as fail-safe design and redundant design e overall system and equipment, should be tak product is used for equipment which demands h precision, such as ; ntrol and safety equipment (aircraft, train, auto * Gas leakage sensor breakers * Rescue and oment	the absolute maxim mentioned below. e ment ent listed in paragra spective paragraphs considering en to ensure reliabil high reliability and mobile etc.) security equipment	um ratings uphs s. ity
and safety in function * Space equipment * Nuclear power con	product for equipment which require extremel and precision, such as ; * Telecommunication equipment (for trunk ntrol equipment * Medical equipment	lines)	
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	DG996034	Jun/16
	MODEL No.	PAGE
	GL5ZV43	1/10
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	· · · ·	
_GL5ZV43 Spec	<u>afication</u>	
1. Application		
This specification applies to the light emitting diode device I	Model No. GL5ZV43.	
[AlGaInP (dicing or scribe/brake type) Amber LED dev	rice]	
2. Outline dimensions and pin connections		e 2.
3. Ratings and characteristics	······Refer to the attached sheet Pag	e 3~4.
3-1. Absolute maximum ratings		
3-2. Electro-optical characteristics		
3-3. Derating Curve		
3-4. Characteristics Diagram		
4. Reliability ·····		- 5
4-1. Test items and test conditions	Refer to the attached sheet Fage	с J.
4-2. Measurement items and Failure judgement criteria		
5. Incoming inspection ······		e 6.
5-1. Applied standard		
5-2. Sampling method and level		
5-3. Test items, judgement criteria and classifica of defect		
5-4. Test items the surface is be applied for flat type, judgem	ent criteria and classifica of defect	
6. Supplement ·····		7~8
6-1. Packing	Refer to the attached sheet I age	., 0.
6-2. Luminous intensity rank		
6-3. Dominant wavelength rank		
6-4. Environment		
7. Precautions for use ·····	Refer to the attached sheet Page	• 9∼ 10.
7-1. Lead forming method		
7-2. Notice of installation		
7-3. Soldering Conditions		

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Unit	Material	Finish	Drawing No.
	Lead: (Fe) Cold rolled steel		
<u> </u>	Package : Epoxy resin	Lead : Sn plated or wave soldering	51106015

DG996034	Jun/16/99	
MODEL No.	PAGE	
GL5ZV43	3/10	

3. Ratings and characteristics

3-1. Absolute	maximum ratin	gs			(Ta=25°C)
Parameter		Symbol		Value		Unit
Power dissipation	n	Р		130		mW
Continuous forwa	ard current	IF		50		mA
Peak forward cur	rent(Note 1)	I _{FM}		100		mA
Derating factor	DC	-		0.67		mA/℃
	Pulse	-		1.33		mA/C
Reverse voltage		V _R		5		v
Operating temper	rature	Topr	-40	~	85	°C
Storage temperat	ure	Tstg	-40	~	100	°C
Soldering temper	ature(Note 2)	Tsol	260 (w	vithin 5 se	conds)	°C

(Note 1) Duty ratio=1/10,Pulse width=0.1ms

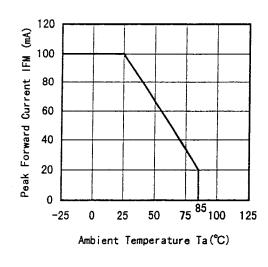
(Note 2) At the position of 1.6mm from the bottom resin package

3-2. Electro-optical character	istics				(Ta=25°C)
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V _F		-	2.1	2.6	v
Luminous intensity (Note 3)	Iv		3417	8000	—	mcd
Peak emission wavelength	λp	IF=20mA		591	-	nm
Dominant wavelength	λd		-	588	—	nm
Spectrum radiation bandwidth	$\bigtriangleup \lambda$			15	—	nm
Reverse current	IR	VR=4V	-	—	100	μA
Terminal capacitance	Ct	V=0V,f=1MHz	- 1	60	-	pF
Viewing Angle	201/2	IF=20mA	-	8	-	deg.

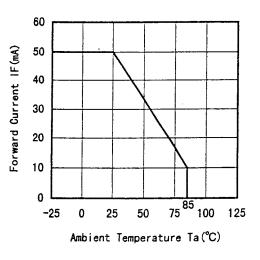
(Note 3) Refer to the suplement item 6. regarding the standard of rank classification.

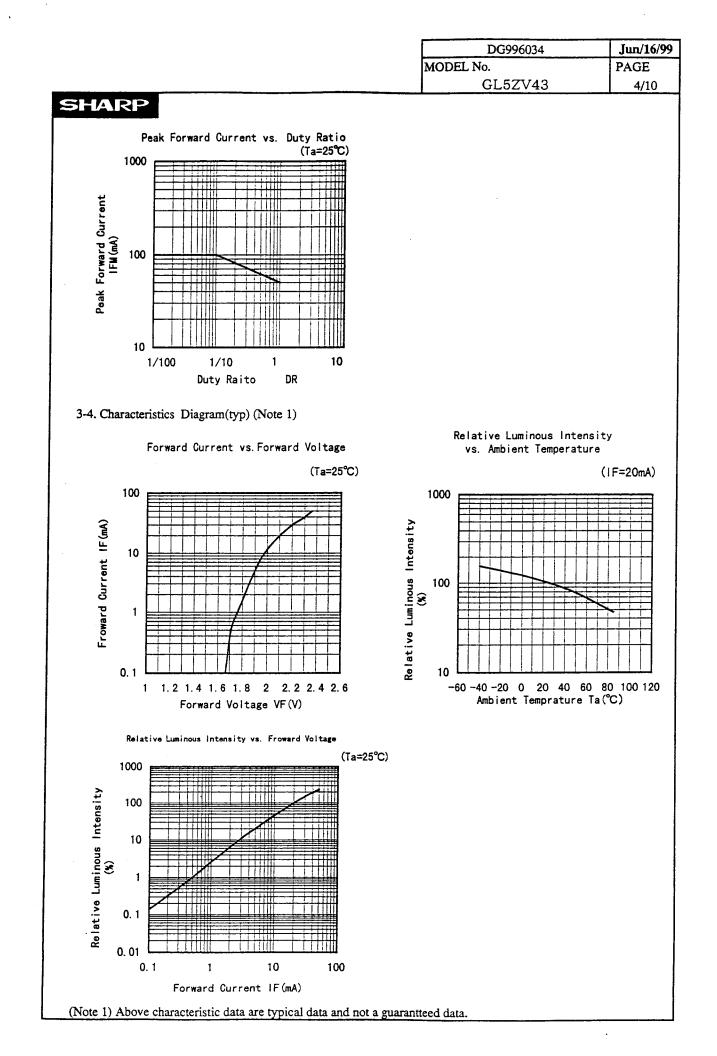
3-3. Derating Curve

Peak Forward Current Derating Curve



Forward Current Derating Curve





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4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1. Test items and test of	conditions	Confidence l	evel: 90%
Test items	Test conditions	Samples (n) Defective (C)	LTPD (%)
Solderability	$230\pm5^{\circ}$ C, 5s Prior disposition : Dip in rosin flux	n=11, C=0	20
Soldering temperature	260±5℃, 5s	n=11, C=0	20
Mechanical shock	15 000m/s ² , 0.5ms, 3times / ±X,±Y,±Z direction	n=11, C=0	20
Variable frequency vibration	200m/s^2 , 100 to 2 000 to 100Hz/sweep for 4min. ,4times/ \pm X, \pm Y, \pm Z direction	n=11, C=0	20
Terminal strength (Tension)	Weight:10N, 5s/each terminal	n=11, C=0	20
Terminal strength (Bending)	Weight:5N, $0^{\circ} \rightarrow 90^{\circ} \rightarrow 0^{\circ} \rightarrow -90^{\circ} \rightarrow 0^{\circ}$ / each terminal	n=11, C=0	20
Temperature cycling	-40°C(30min)~+100°C(30min),30 cycles	n=22, C=0	10
High temp. and high humidity storage	Ta=+60°C, 90%RH, t=1000h	n=22, C=0	10
High temperature storage	Ta=100°C, t=1000h	n=22, C=0	10
Low temperature storage	Ta=-40°C, t=1000h	n=22, C=0	10
Operation life	Ta=25℃, I _F MAX, t=1000h *3	n=22, C=0	10

4-2. Measurement items and Failure judgement criteria *1

Measurement	Symbol	Failure judgement criteria *2
Forward voltage	V _F	$V_F > U.S.L. \times 1.2$
Reverse current	I _R	I _R > U.S.L. × 2.0
Luminous intensity	Iv	Iv > The first stage value \times 2.0 or The first stage value \times 0.5 > Iv

X Solderability : Solder shall be adhere at the area of 95% or more of dipped portion.

X Terminal strength : Package is not destroyed, and terminal is not slack.

*1: Measuring condition is in accordance with specification.

*2: U.S.L. is shown by Upper Specification Limit.

*3: IF MAX.is shown by forward current of absolute maximum ratings.

DG996034	Jun/16/99
MODEL No.	PAGE
GL5ZV43	6/10

5. Incoming inspection

SHARP

5-1. Applied standard : ISO 2859-1

5-2. Sampling method and level : A single sampling plan, normal inspection level $\, \mathrm{II}$

: AQL Major defect : 0.065%

Minor defect : 0.4%

5-3. Test items, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
1	Disconnection	Not emit light	
2	Position of Cutting off rim	Different from dimension	Major defect
3	Reverse terminal	Different from dimension	
4	Outline dimensions	Not satisfy outline specification	
5	Characteristics	Over the limit value of specification at V_F , I_R , and I_V	
6	Cut off the rim	Exceed -0.2mm	
7	Foreign substance	White point : Exceed ϕ 0.3mm (on top view)Black point : Exceed ϕ 0.3mm (on top view)String form : Exceed 3.0mm (on top view)	
8	Scratch	Exceed ϕ 0.3mm or 0.1mm × 1.0mm (on top view)	Minor defect
9	Void	Exceed ϕ 0.3mm (on top view)	
10	Uneven density of material for scattering	Extremely uneven density	
11	Unbalanced center	Exceed ±0.25mm from package center	
12	Вил	Exceed +0.2mm againstprovided dimension	
13	Insertion position of terminal	Insertion position of terminal	

5-4. Test items the surface is be applied for flat type, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
14	Chapped the surface	The surface chapped is striking for see the lamp top	Minor defect
15	Hollow the surface	The surface hollow is striking for see the lamp top	

					MODEL No.	996034	Jun/
						277/40	PAG
					GLt	5ZV43	7,
Product (Indication lab <u>SHIPMEN</u> PART No. QUANTITY LOT No. KAN S H A MADE II (1) Production (2) Support co	Dipos the same 1 t weight : 0.28 pel sample) IT TABLE GL5ZV43 250 99B19 IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	8g (One F ← Mode ← Quan ← Lot n ← Lumin ← Produ o be indic	Product, Typ.) el number atity of produ number * nous intensity nant wavelen action countr) cts y rank gth rank y	nto pack and put fol * ① ②	llowing label by p 	ack.
 (4) Month of p (5) Date of pro- (6-1-2. Outer pa Put 8 pa (approx) (6-1-3. Outer pa pa	oduction(01~ ackage acks (the same imately 670g p	(to be 2 (31) e luminou per one of e dimensio	indicated alp is intensity ra uter package) on	habetically nk) into out	with January corresp er package.	ponding to A)	
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	DG996034	Jun/16/99
	MODEL No.	PAGE
	GL5ZV43	8/10
5HARP		

6-4. Environment

6-4-1. Ozonosphere destructive chemicals.

- (1) The device doesn't contain following substance.
- (2) The device doesn't have a production line whose process requires following substance. Restricted part: CFCs,halones, CCl₄, Trichloroethane(Methychloroform)

6-4-2. Bromic non-burning materials

The device doesn't contain bromic non-burning materials(PBBOs,PBBs)

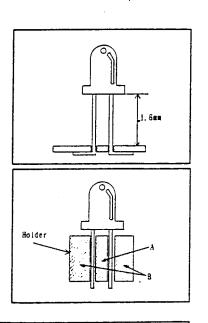
	DG996034	Jun/16/99
	MODEL No.	PAGE
	GL5ZV43	9/10
SHARP		
7. Precautions for use		
 7-1. Lead forming method Avoid forming a lead pin with the lead pin base as a fulcrum:be sure to hold a lead pin firmly when forming. Lead pins should be formed before soldering 7-2. Notice of installation 	g. Hold a lead pin firmly when forming	
 7-2-1 installation on a PWB When mounting an LED lamp on a PWB, do not apply physical stress to the lead pins. The lead pin pitch should match the PWB pin-hole pitch:absolutely avoid widening or narrowing the lead pins. When positioning an LED lamp, basically employ an LED with tie-bar cut or use a spacer. 		NG

- 7-2-2 When an LED 1 is mounted directly on a PWB If the bottom face of an LED lamp is mounted directly on single-sided PWB, the base of the lead pins may be subjected to physical stress due to PWB warp, cutting or clinching of lead pins. Prior to use, be sure to check that no disconnection inside of the resin or damage to resin etc., is found. When an LED lamp is mounted on a double-sided PWB, the heat during soldering affects the resin; therefore, keep the LED lamp more that 1.6mm afloat above the PWB.
- 7-2-3 Installation using a holder During an LED lamp positioning, when a holder is used, a holder should be designed not to subject lead pins to any undue stress.
- (Note)Pay attention to the thermal expansion coefficient of the material used for the holder. Since the holder expands and contracts due to preheat and soldering heat, mechanical stress may be applied to the lead pins, resulting in disconnection.

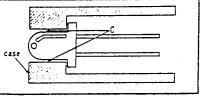
7-2-4 Installation to the case

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Do not fix part C with adhesives when fixed to the case as shown in Figure. A hole of the case should be designed not to subject the inside of resin to any undue stress.



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DG996034	Jun/16/99
MODEL No.	PAGE
GL5ZV43	10/10

SHARP

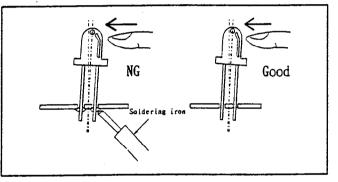
7-3. Soldering Conditions

Solder the lead pins under the following conditions

oblact the read bing ander	
Type of Soldering	Conditions
1. Manual soldering	295℃±5℃, within 3 seconds
2. Wave soldering	260℃±5℃, within 5 seconds
3. Auto soldering	Preheating 70°C to 80°C, within 30 seconds Soldering 245°C±5°C, within 5 seconds

(Note) Avoid dipping resin into soldering bath.

Avoid applying stress to lead pins while they are heated. For example, when the LED lamp is moved with the heat applied to the lead pins during manual soldering or solder repair, disconnection may occur.



7-4. For cleaning

- (1) Solvent cleaning : Solvent temperature 45℃ or less Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

In case when the other solvent is used, there are cases that the packaging resin is eroded. Please use the other solvent after thorough confirmation is performed in actual using condition.